

TPS3803x-Q1EVM Voltage Supervisors User 's Guide

This user's guide describes initialization and timing supervision for the TPS3803x-Q1EVM evaluation module (EVM). The EVM can be used to test the TPS3803G15-Q1, TPS3805H33-Q1, and TPS3803-01-Q1 voltage detectors. This guide contains the EVM schematic, bill of materials (BOM), assembly drawing, and top and bottom board layouts.

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1 Introduction

The TPS3803x-Q1EVM is for evaluating a group of voltage detectors that provide circuit initialization and timing supervision. The voltage detectors are used primarily in digital signal processing and processorbased systems. The EVM supports a supply voltage range between 1.3 V and 6 V and an input voltage range between 0 V and (V_{DD} + 0.3) V. Additionally, each voltage detector has its own independent circuit for evaluation on the EVM. The open-drain voltage detectors are also provided with a pullup resistor option to enable evaluation of these devices.



Figure 1. TPS3803X-Q1 EVM Board

1.1 Related Documentation

TPS3803x-Q1 Voltage Detectors data sheet, SGLS228

1.2 TPS3803x-Q1 Applications

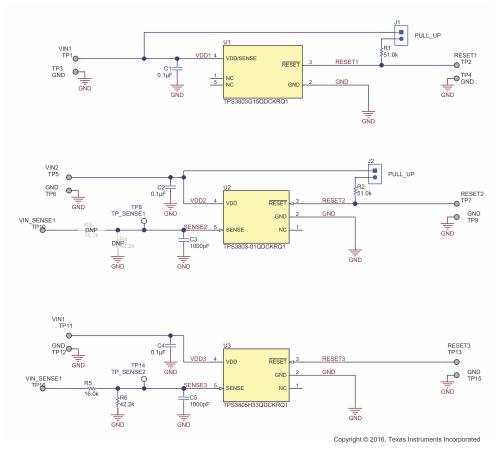
- Automotive ECU Supply Rail Power Distribution and Switching
- Precision Current Limiting
- USB Ports and Hubs

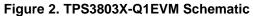


2 Schematic, Bill of Materials, and Layout

This section provides a detailed description of the TPS3803X-Q1EVM Schematic, bill of materials (BOM), and layout.

2.1 TPS3803X-Q1EVM Schematic





2.2 TPS3803X-Q1EVM Bill of Materials

| DESIGNATOR | QUANTIT Y | VALUE | DESCRIPTION | PACKAGE REFERENCE | PART NUMBER | MANUFACTURER |
|--|--------------|---------|--|----------------------------------|-------------------------|--------------------------------|
| !PCB1 | 1 | | Printed Circuit Board | | MSA021 | Any |
| C1, C2, C4 | 3 | 0.1 µF | CAP, CERM, 0.1 µF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0805 | 0805 | CGA4J2X7R2A104K125AA | TDK |
| C3, C5 | 2 | 1000 pF | CAP, CERM, 1000 pF, 100 V, ±10%, X7R, AEC-Q200 Grade 1, 0603 | 0603 | CGA3E2X7R2A102K080AA | TDK |
| GND, GND, GND, GND, GND, GND, RESET1, RESET2, RESET3, VDD1, VDD2, VDD3, VIN_SENSE2, VIN_SENSE3 | 14 | | PCB Pin, Swage Mount, TH | PCB Pin(2505-2) | 2505-2-00-44-00-00-07-0 | Mill-Max |
| J1, J2 | 2 | | Header, 100mil, 2x1, Tin, TH | Header, 2 PIN, 100mil, Tin | PEC02SAAN | Sullins Connector Solutions |
| R3, R6 | 2 | 51.0 kΩ | RES, 51.0 k, 0.1%, 0.125 W, AEC- Q200 Grade 0, 0805 | 0805 | ERA-6AEB513V | Panasonic |
| R4 | 1 | 16.0 kΩ | RES, 16.0 k, 0.1%, 0.1 W, 0603 | 0603 | RG1608P-163-B-T5 | Susumu Co Ltd |
| R5 | 1 | 42.2 kΩ | RES, 42.2 k, 0.1%, 0.1 W, 0603 | 0603 | RG1608P-4222-B-T5 | Susumu Co Ltd |
| TP1, TP2 | 2 | SMT | Test Point, Miniature, SMT | Testpoint_Keystone _Miniature | 5015 | Keystone |
| U1 | 1 | | Voltage Detector, DCK0005A | DCK0005A | TPS3803G15QDCKRQ1 | Texas Instruments |
| U2 | 1 | | VOLTAGE DETECTOR, DCK0005A | DCK0005A | TPS3803-01QDCKRQ1 | Texas Instruments |
| U3 | 1 | | VOLTAGE DETECTOR, DCK0005A | DCK0005A | TPS3805H33QDCKRQ1 | Texas Instruments |
| FID1, FID2, FID3 | 0 | | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A |
| R1 | 0 | 16.0 kΩ | RES, 16.0 k, 0.1%, 0.1 W, 0603 | 0603 | RG1608P-163-B-T5 | Susumu Co Ltd |
| R2 | 0 | 42.2 kΩ | RES, 42.2 k, 0.1%, 0.1 W, 0603 | 0603 | RG1608P-4222-B-T5 | Susumu Co Ltd |

Table 1. BOM



Schematic, Bill of Materials, and Layout

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2.3 Layout and Component Placement

Figure 3 and Figure 4 top and bottom assemblies of the printed circuit board (PCB) show the component placement on the EVM.

Figure 5 and Figure 6 show the top and bottom layout of the EVM. Figure 7 and Figure 8 show the top and bottom layers of the EVM. Figure 9 and Figure 10 show the top and bottom solder masks.

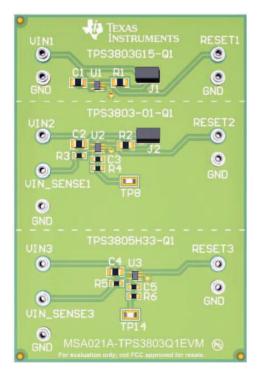


Figure 3. Component Placement—Top Assembly

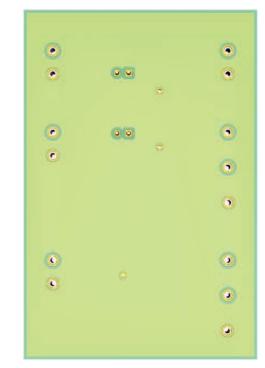


Figure 4. Component Placement—Bottom Assembly





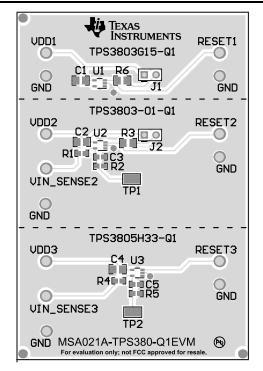


Figure 5. Layout—Top

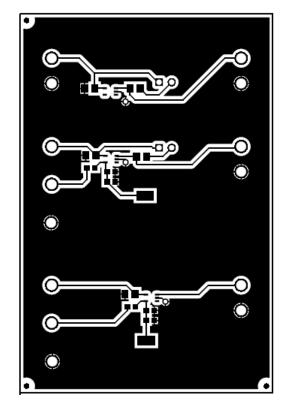


Figure 7. Top Layer

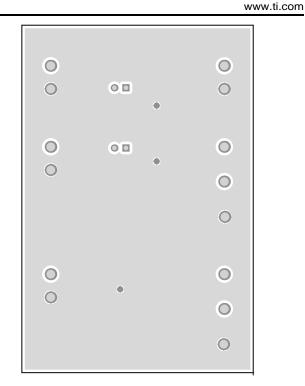


Figure 6. Layout—Bottom

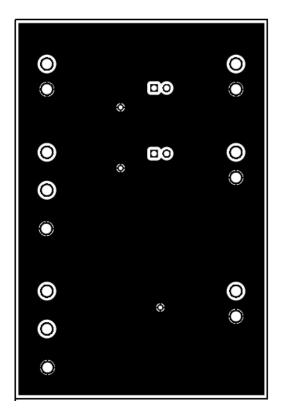


Figure 8. Bottom Layer



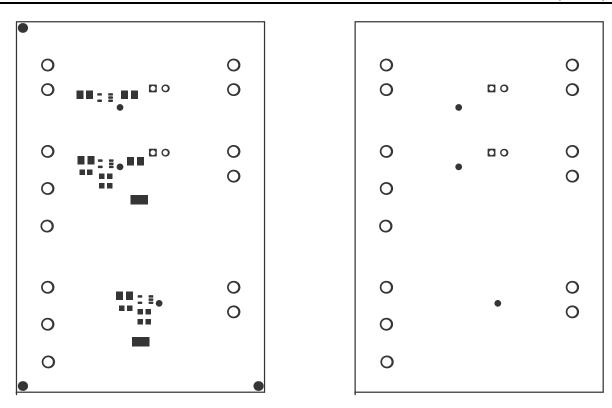


Figure 9. Top Solder Mask

Figure 10. Bottom Solder Mask

3 Setup and Operation

3.1 Input and Output Connectors

There are several methods and types of input and output (I/O) connections on the EVM including:

- Input/Output Turret Connections: For both positive and negative (GND) input and output supplies
- Test Points: For SENSE pins
- Two-Pin Jumpers: For manual pullup voltages

Table 2 lists the test points and functional descriptions.

Table 2. Test Points

| Test | Point | Function | Description |
|-------------------------|-------|-----------------|--|
| Number Silkscreen Label | | | Description |
| TP1 | TP1 | Probe SENSE pin | Allows monitoring of the SENSE input pin for the TPS3803-01-Q1 |
| TP2 | TP2 | Probe SENSE pin | Allows for monitoring of the SENSE input pin for the TPS3805H33-Q1 |

The jumpers onboard the TPS3803X-Q1EVM allows the user to define the output voltage. When the jumpers are enabled, the RESET value has a voltage level of V_{DD} when in the HIGH state. If the jumpers are disabled, the jumper pins can apply the desired voltage for the HIGH state of the RESET pin. Table 3 includes jumper settings for the EVM.



Setup and Operation

Table 3. Manual Enable or Auto-Retry Jumpers

| Jumper | Device | Enabled | Disabled |
|--------|---------------|--|--|
| J1 | TPS3803G15-Q1 | RESET1 gets pulled up to V_{DD} | Manual pull-up voltage must be applied to RESET1 |
| J2 | TPS3803-01-Q1 | RESET2 gets pulled up to $V_{\mbox{\scriptsize DD}}$ | Manual pull-up voltage must be applied to RESET2 |

3.2 EVM Setup

The EVM setup section details what test equipment the user needs to use the EVM and how to properly setup the EVM environment.

3.2.1 Recommended Test Equipment

The following is the recommended test equipment:

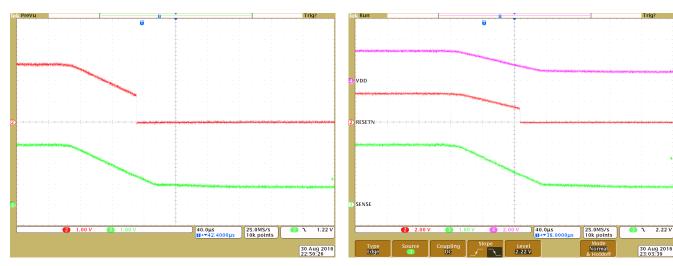
- Two-channel storage oscilloscope
- Current probe
- Voltage Probe
- Adjustable DC power supply with at least 2.5-V to 6.5-V output and a 10-A current limit
- Digital Multimeter or a Volt-Ohmmeter
- A passive or active load capable of handling up to 3 A

3.3 Basic Operation

3.3.1 Measuring Propagation Delay

The user should read and be familiar with the TPS3803X-Q1 datasheet contents before using the EVM. To test the propagation delay, the user must monitor the RESET pin using an oscilloscope. Additionally, the user can monitor the SENSE and input voltages using an oscilloscope. A power supply is necessary to supply the board with the desired supply voltage. Additionally, a multimeter can probe test points.

Figure 11 shows the high-to-low delay of the TPS3803G15-Q1 device with jumper J1 enabled. Figure 12 shows the high-to-low delay of the TPS3803-01-Q1 device with jumper J2 enabled. Figure 13 shows the high-to-low delay of the TPS3805H33-Q1 device.



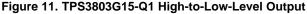


Figure 12. TPS3803-01-Q1 High-to-Low-Level Output



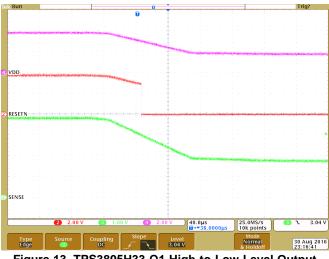


Figure 13. TPS3805H33-Q1 High-to-Low-Level Output

Figure 14 shows the low-to-high delay of the TPS3803G15-Q1 device with jumper J1 enabled. Figure 15 shows the low-to-high delay of the TPS3803-01-Q1 device with jumper J2 enabled. Figure 16 shows the low-to-high delay of the TPS3805H33-Q1 device.



Figure 14. TPS3803G15-Q1 Low-to-High-Level Output

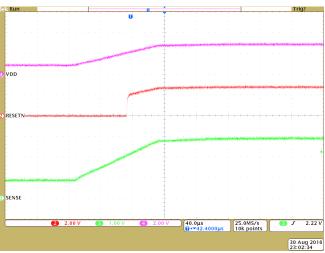


Figure 15. TPS3803-01-Q1 Low-to-High-Level Output



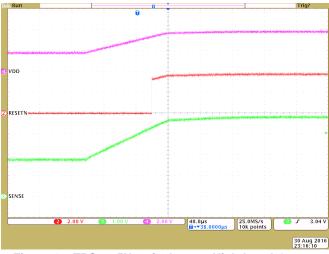


Figure 16. TPS3805H33-Q1 Low-to-High-Level Output

3.3.2 Measuring the Rising and Falling Voltage Thresholds

To test the voltage thresholds, monitor the RESET pin using a multimeter or voltmeter. Additionally, the user can monitor SENSE and input voltages using a multimeter, if desired. A power supply is necessary to supply the EVM board with the desired supply voltage.

Table 4 shows the rising voltage thresholds on the RESET pin for the TPS3803G15-Q1, the TPS3803-01-Q1, and the TPS3805H33-Q1 device. Note that both jumpers are enabled for this example and that the rising voltage threshold maximum value takes account of power on hysteresis.

| Device | Minimum Value (V) | Maximum Value (V) | Measured Value (V) |
|---------------|-------------------|-------------------|--------------------|
| TPS3803G15-Q1 | 1.38 | 1.45 | 1.43 |
| TPS3803-01-Q1 | 1.7 | 1.98 | 1.73 |
| TPS3805H33-Q1 | 3 | 3.13 | 3.13 |

Table 5 shows the falling voltage thresholds on the RESET pin for the TPS3803G15-Q1, the TPS3803-01-Q1, and the TPS3805H33-Q1 device. Note that both jumpers are enabled for this example.

Table 5. Falling Voltage Thresholds

| Device | Minimum Value (V) | Maximum Value (V) | Measured Value (V) |
|---------------|-------------------|-------------------|--------------------|
| TPS3803G15-Q1 | 1.38 | 1.42 | 1.4 |
| TPS3803-01-Q1 | 1.7 | 1.73 | 1.7 |
| TPS3805H33-Q1 | 3 | 3.1 | 3.09 |

Revision History

| DATE | REVISION | NOTES |
|---------------|----------|-----------------|
| November 2016 | * | Initial Release |

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This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 Japan

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- 3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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 - 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
 - 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
 - 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
 - 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
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